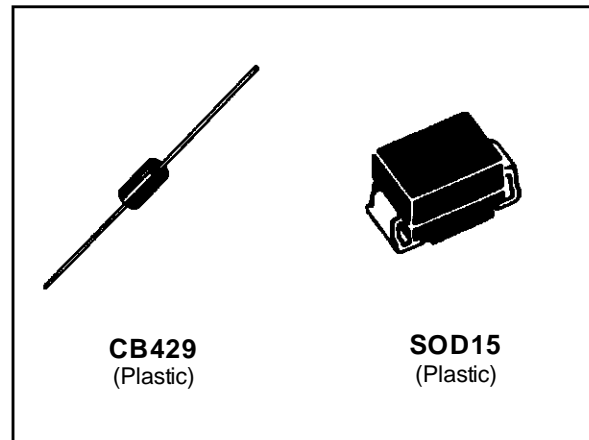


## TRISIL DISCRETE SOLUTION FOR ISDN PROTECTION

### FEATURES

- UNIDIRECTIONAL CROWBAR PROTECTION.
- PEAK PULSE CURRENT :  
I<sub>PP</sub> = 75 A , 10/1000 μs.
- HOLDING CURRENT = 150mA.
- BREAKDOWN VOLTAGE:  
TPU58/SMTHDT58 = 58V.  
TPU80/SMTHDT80 = 80V.  
TPU120/SMTHDT120 = 120V.
- PACKAGES:  
TPUxx = AXIAL DIODE.  
SMTHDTxx = SURFACE MOUNT PACKAGE.



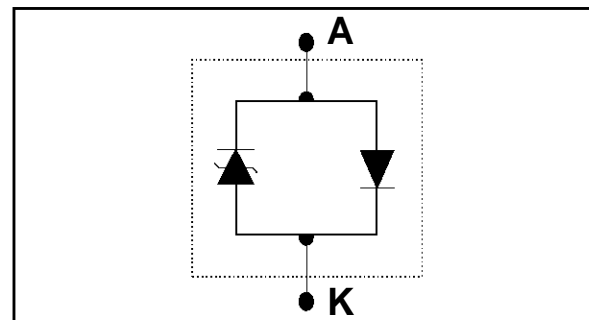
### DESCRIPTION: TRIBALANCED PROTECTION

Dedicated protection devices for ISDN LINE CARD and high speed data telecom lines.

Used with the recommended configuration using 3 components, they will provide =

- Dual bidirectionnal protection, with fixed breakdown voltage in both common and differential modes.
- Low capacitances from lines to ground.
- Very good capacitance balance : ΔC= 30 pF.

### FUNCTIONAL DIAGRAM.



### ABSOLUTE RATINGS (limiting values) (-40°C ≤ T<sub>amb</sub> ≤ +85°C)

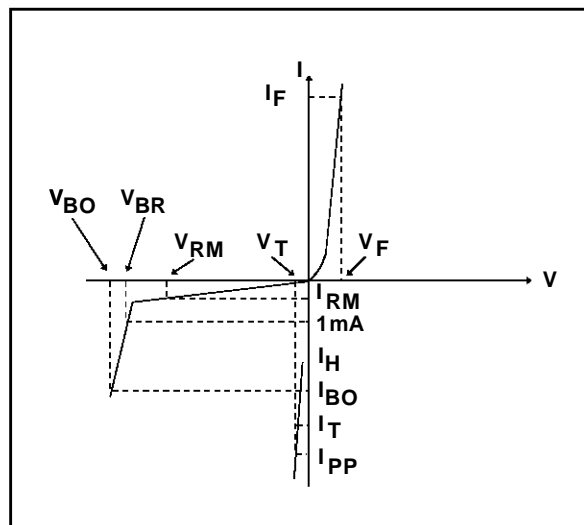
Symbol	Parameter		Value	Unit
I <sub>PP</sub>	Peak pulse current	10/1000 μs 8/20 μs	75 150	A
I <sub>TSM</sub>	Non repetitive surge peak on-state current	tp = 20 ms	30	A
di/dt	Critical rate of rise of on-state current	Non repetitive	100	A/μs
dv/dt	Critical rate of rise of off-state voltage	67% V <sub>BR</sub>	5	KV/μs
T <sub>stg</sub> T <sub>j</sub>	Storage and operating junction temperature range		- 40 to + 150 + 150	°C °C

### THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
R <sub>th</sub> (j-l)	Junction-leads Thermal Resistance	CB429 SOD15	20 20	°C/W °C/W

**ELECTRICAL CHARACTERISTICS**

Symbol	Parameter
$V_{RM}$	Stand-off voltage
$V_{BR}$	Breakdown voltage
$V_{BO}$	Breakover voltage
$I_H$	Holding current
$V_T$	On-state voltage
$V_F$	Forward Voltage Drop
$I_{BO}$	Breakover current
$I_{PP}$	Peak pulse current



**PARAMETERS RELATED TO THE DIODE.**

Parameter	Test conditions	Value	Unit
$V_F$	$I_F = 5A, T_P = 500 \mu s$	5	V

**PARAMETERS RELATED TO THE PROTECTION TRISIL.**

Types	$I_R @ V_{RM}$		$V_{BR} @ I_R$		$V_{BO}$	$I_{BO}$		$I_H$	$V_T$	$C$
	max		min		max	min	max	min	max	max
	$\mu A$	V	V	mA	V	mA	mA	mA	V	pF
TPU58/SMTHDT58	10	56	58	1	80	150	800	150	5	400
TPU80/SMTHDT80	10	68	80	1	120	150	800	150	5	250
TPU120/SMTHDT120	10	102	120	1	180	150	800	150	5	200

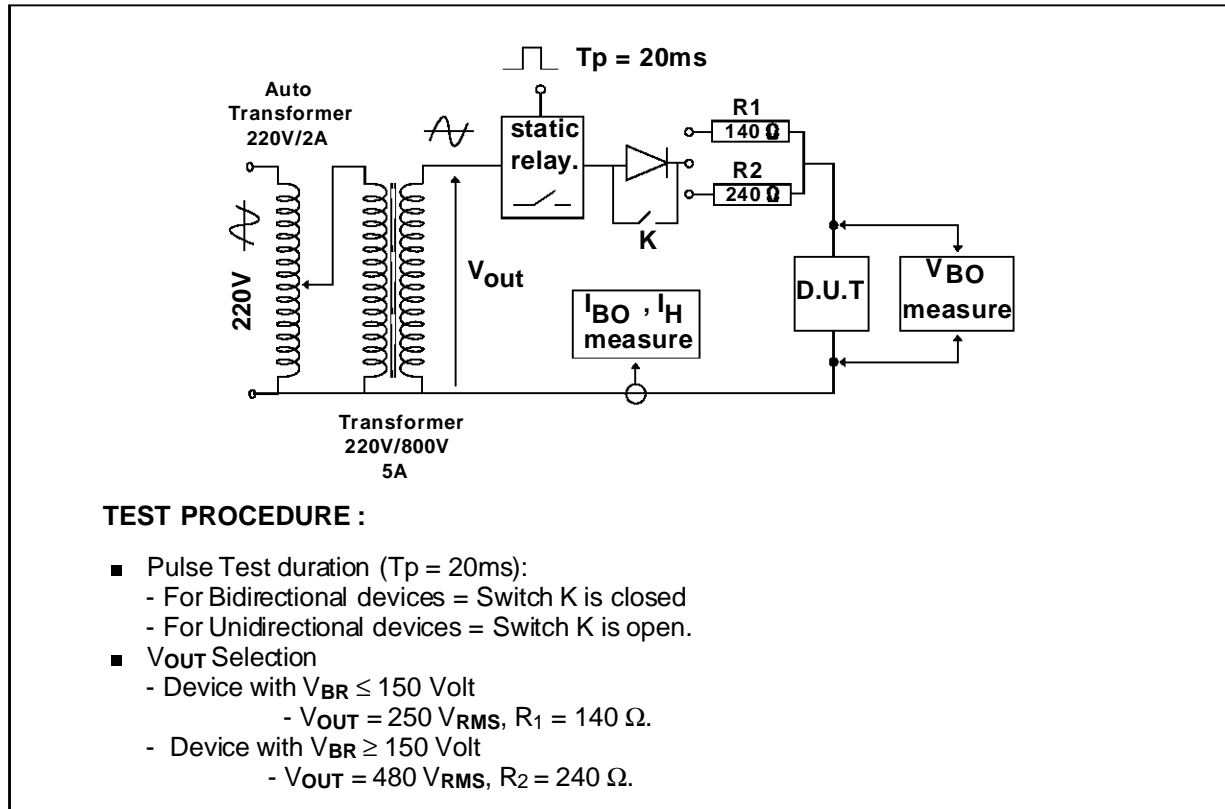
All parameters tested at 25 °C, except where indicated.

**Note 1 :** See the reference test circuit for  $I_H$ ,  $I_{BO}$  and  $V_{BO}$  parameters.

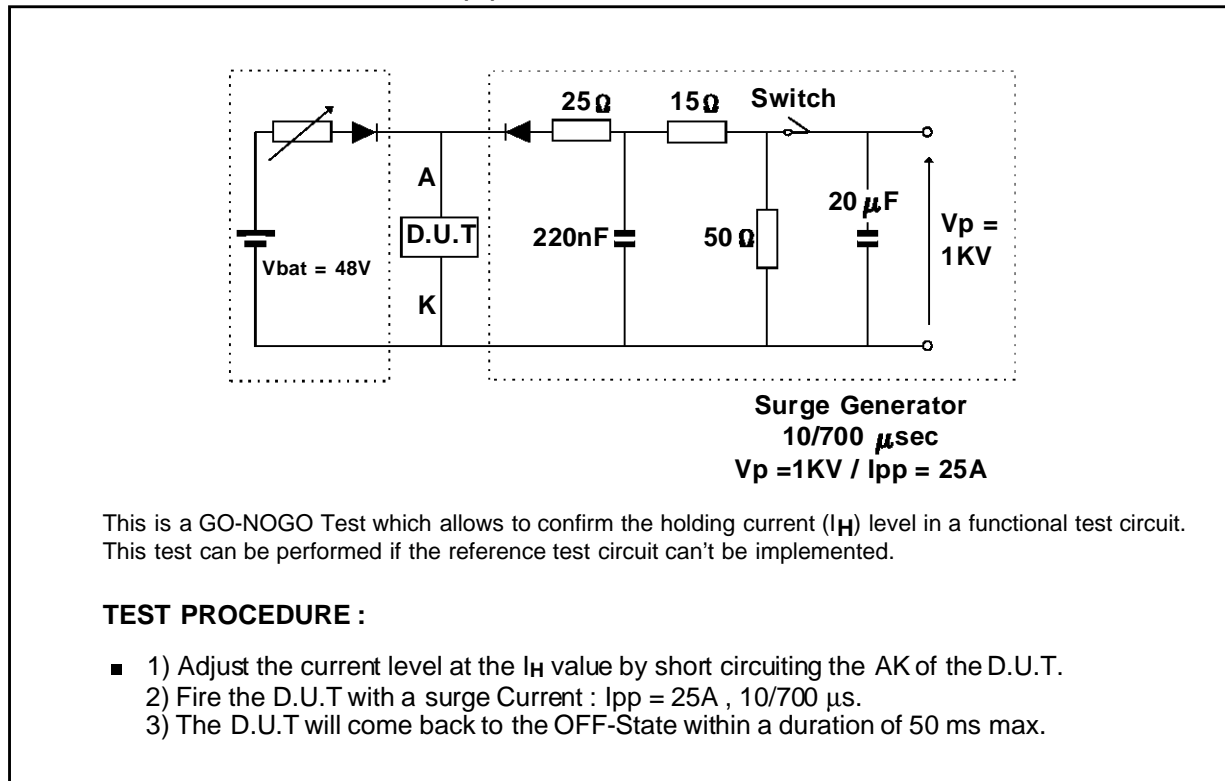
**Note 2 :** Square pulse  $T_p = 500 \mu s - I_T = 5A$ .

**Note 3 :**  $V_R = 1V, F = 1MHz$ .

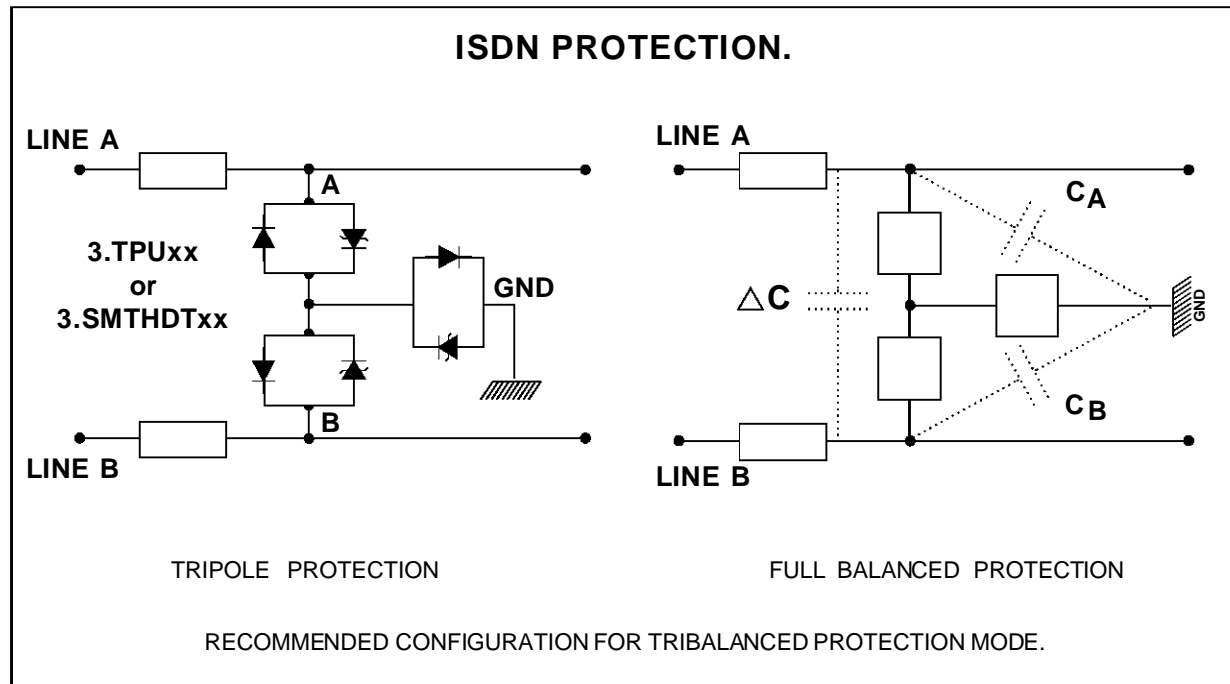
**REFERENCE TEST CIRCUIT FOR  $I_H$ ,  $I_{BO}$  and  $V_{BO}$  parameters :**



**FUNCTIONAL HOLDING CURRENT ( $I_H$ ) TEST CIRCUIT = GO - NOGO TEST.**



APPLICATION NOTE

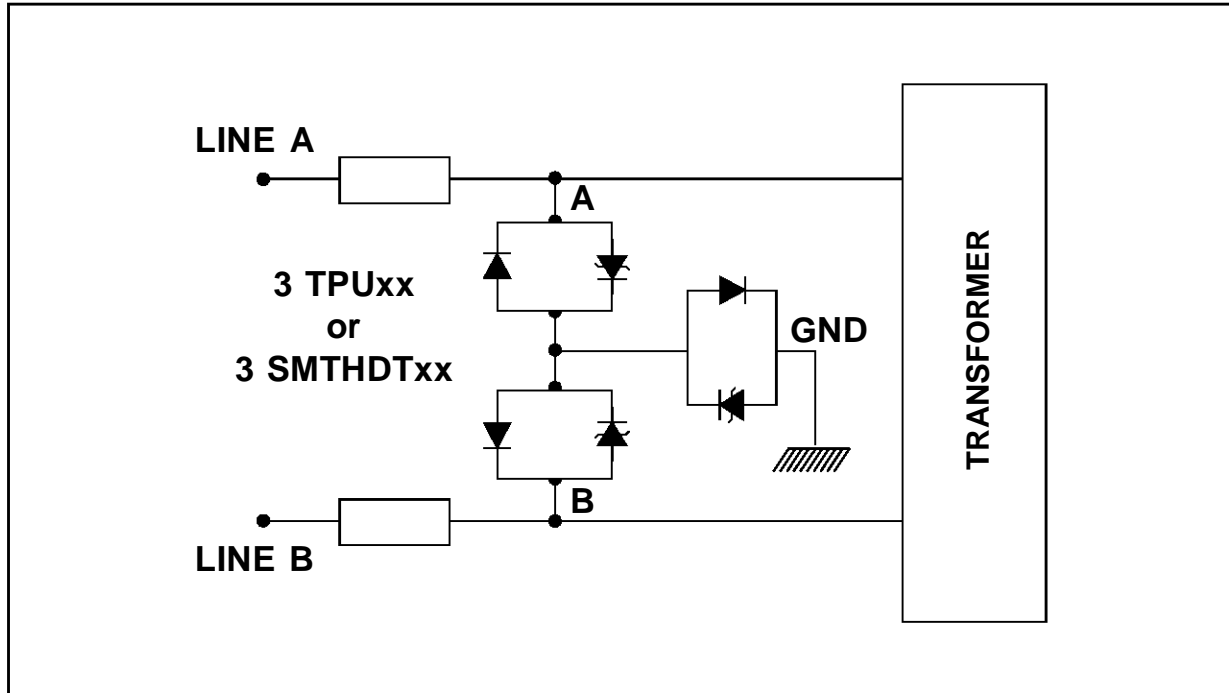


CAPACITANCE CHARACTERISTICS

Type	CONFIGURATION		C <sub>A</sub> pF Max	C <sub>B</sub> pF Max	ΔC pF Max
	LINE A	LINE B			
TPU58/SMTHDT58	48	0	80	60	30
TPU80/SMTHDT80	56	0	70	50	30
TPU120/SMTHDT120	110	0	70	50	30

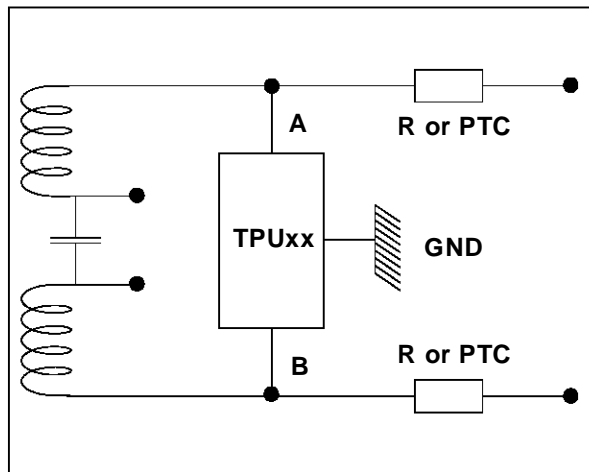
APPLICATION NOTE

Discrete ISDN Protection solution

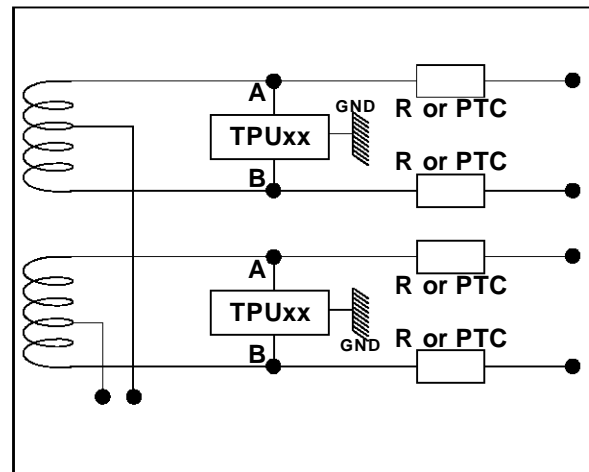


EQUIVALENT PROTECTION FUNCTION

U Interface Protection



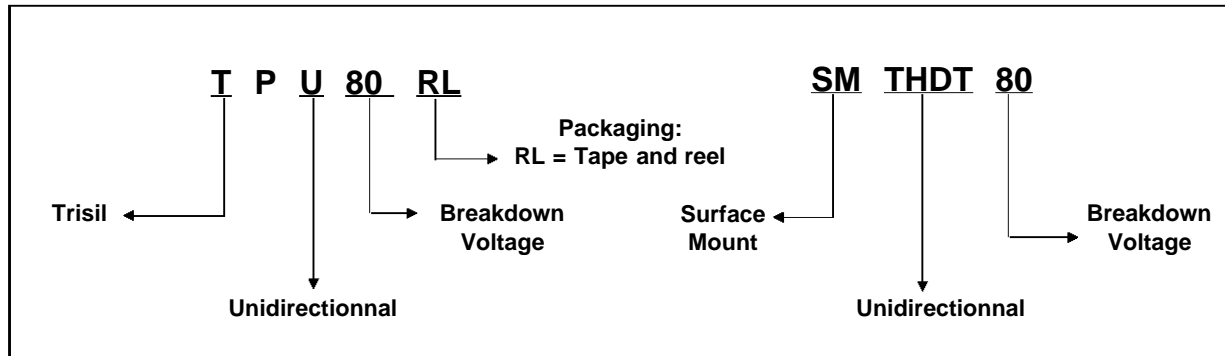
S Interface Protection



This topology assumes the same breakdown voltage level in positive and negative for differential or common mode surge.

# TPUxx/SMTHDTxx

## ORDER CODE



## MARKING

Package	Type	Marking
CB429	TPU58	TPU58
	TPU80	TPU80
	TPU120	TPU120

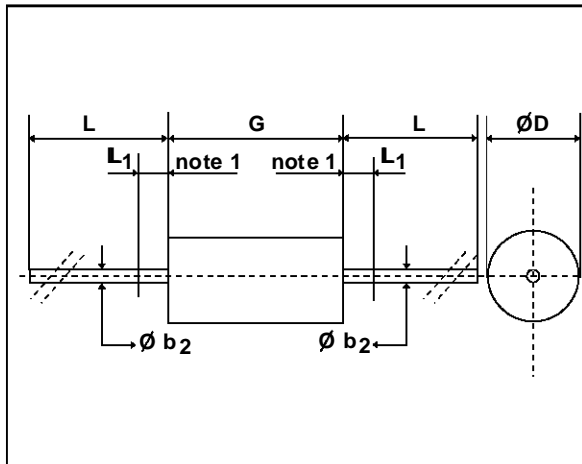
A white band indicates the cathode

Package	Type	Marking
SOD15	SMTHDT58	W01
	SMTHDT80	W03
	SMTHDT120	W05

A white band indicates the cathode

## PACKAGE MECHANICAL DATA

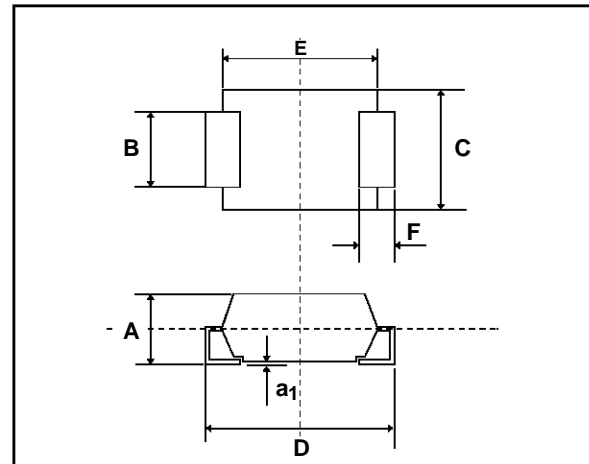
### CB429



Ref	Millimeters		Inches	
	min	max	min	max
Ø b <sub>2</sub>	-	1.06	-	0.042
Ø D	-	5.1	-	0.20
G	-	9.8	-	0.386
L	26	-	1.024	-
L <sub>1</sub>	-	1.27	-	0.050

**note1:** The diameter Ø b<sub>2</sub> is not controlled over zone L<sub>1</sub>.

### SOD15



Ref	Millimeters		Inches	
	min	max	min	max
A	2.5	3.1	0.098	0.122
a <sub>1</sub>	-	0.2	-	0.008
B	2.9	3.1	0.114	0.122
C	4.8	5.2	0.190	0.200
D	7.6	8.0	0.300	0.315
E	6.3	6.6	0.248	0.259
F	1.3	1.7	0.051	0.067

**Packaging :** Axial Diode CB429 = Products Supplied in Tape and Reel.  
SOD15 =Standard packaging is in Film.

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